

LM2936 Ultra-Low Quiescent Current LDO Voltage Regulator

Check for Samples: [LM2936](#)

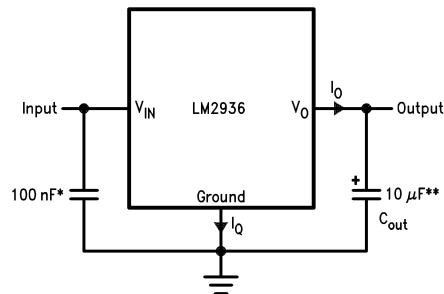
FEATURES

- Ultra Low Quiescent Current ($I_Q \leq 15 \mu\text{A}$ for $I_O = 100 \mu\text{A}$)
- Fixed 3.0V, 3.3V or 5.0V with 50 mA Output
- $\pm 2\%$ Initial Output Tolerance
- $\pm 3\%$ Output Tolerance Over Line, Load, and Temperature
- Dropout Voltage Typically 200 mV @ $I_O = 50 \text{ mA}$
- Reverse Battery Protection
- -50V Reverse Transient Protection
- Internal Short Circuit Current Limit
- Internal Thermal Shutdown Protection
- 40V Operating Voltage Limit
- 60V Operating Voltage Limit for LM2936HV
- Shutdown Pin Available with LM2936BM Package

DESCRIPTION

The LM2936 ultra-low quiescent current regulator features low dropout voltage and low current in the standby mode. With less than $15 \mu\text{A}$ quiescent current at a $100 \mu\text{A}$ load, the LM2936 is ideally suited for automotive and other battery operated systems. The LM2936 retains all of the features that are common to low dropout regulators including a low dropout PNP pass device, short circuit protection, reverse battery protection, and thermal shutdown. The LM2936 has a 40V maximum operating voltage limit, a -40°C to $+125^\circ\text{C}$ operating temperature range, and $\pm 3\%$ output voltage tolerance over the entire output current, input voltage, and temperature range. The LM2936 is available in a TO-92 package, SOIC-8 and SOT-223 surface mount packages, and a PFM surface mount power package.

Typical Application



* Required if regulator is located more than 2" from power supply filter capacitor.

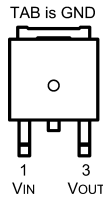
** Required for stability. See [Electrical Characteristics](#) for required values. Must be rated over intended operating temperature range. Effective series resistance (ESR) is critical, see curve. Locate capacitor as close as possible to the regulator output and ground pins. Capacitance may be increased without bound.



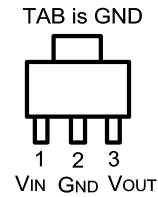
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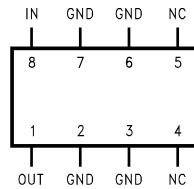
Connection Diagrams



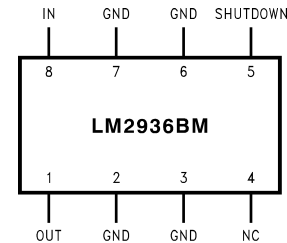
**Figure 1. PFM
Top View**
See Package Number NDP0003B



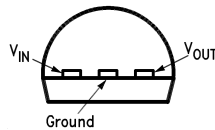
**Figure 2. SOT-223
Top View**
See Package Number DCY0004A



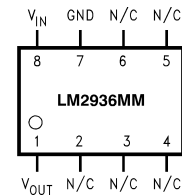
**Figure 3. 8-Pin SOIC (D)
Top View**
See Package Number D0008A



**Figure 4. 8-Pin SOIC (D)
Top View**
See Package Number D0008A



**Figure 5. TO-92
Bottom View**
See Package Number LP0003A



**Figure 6. 8-Pin VSSOP (DGK)
Top View**
See Package Number DGK0008A



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

Absolute Maximum Ratings ⁽¹⁾⁽²⁾

Input Voltage (Survival)	+60V, -50V
ESD Susceptibility ⁽³⁾	2000V
Power Dissipation ⁽⁴⁾	Internally limited
Junction Temperature (T _{Jmax})	150°C
Storage Temperature Range	-65°C to +150°C
Lead Temperature (Soldering, 10 sec.)	260°C

- (1) Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. DC and AC electrical specifications do not apply when operating the device beyond its specified operating ratings.
- (2) If Military/Aerospace specified devices are required, please contact the TI Sales Office/ Distributors for availability and specifications.
- (3) Human body model, 100 pF discharge through a 1.5 kΩ resistor.
- (4) The maximum power dissipation is a function of T_{Jmax}, θ_{JA}, and T_A. The maximum allowable power dissipation at any ambient temperature is P_D = (T_{Jmax} - T_A)/θ_{JA}. If this dissipation is exceeded, the die temperature will rise above 150°C and the LM2936 will go into thermal shutdown.

Operating Ratings

Operating Temperature Range	-40°C to +125°C
Maximum Operating Input Voltage - LM2936	+40V
Maximum Operating Input Voltage - LM2936HV only	+60V
Maximum Shutdown Pin Voltage - LM2936BM only	0V to 40V
TO-92 (LP0003A) θ_{JA}	195°C/W
VSSOP-8 (DGK0008A) θ_{JA}	200°C/W
SOIC-8 (D0008A) θ_{JA}	140°C/W
SOIC-8 (D0008A) θ_{JC}	45°C/W
PFM (NDP0003B) θ_{JA}	136°C/W
PFM (NDP0003B) θ_{JC}	6°C/W
SOT-223 (DCY0004A) θ_{JA}	149°C/W
SOT-223 (DCY0004A) θ_{JC}	36°C/W

Electrical Characteristics for LM2936–3.0

$V_{IN} = 14V$, $I_O = 10\text{ mA}$, $T_J = 25^\circ\text{C}$, unless otherwise specified. **Boldface** limits apply over entire operating temperature range

Parameter	Conditions	Min (1)	Typical (2)	Max (1)	Units
LM2936HV–3.0 Only					
Output Voltage	$5.5V \leq V_{IN} \leq 48V$, $100\ \mu\text{A} \leq I_O \leq 50\ \text{mA}$ (3)	2.910	3.000	3.090	V
Line Regulation	$6V \leq V_{IN} \leq 60V$, $I_O = 1\text{ mA}$		10	30	mV
All LM2936–3.0					
Output Voltage	$4.0V \leq V_{IN} \leq 26V$, $100\ \mu\text{A} \leq I_O \leq 50\ \text{mA}$ (3)	2.940	3.000	3.060	V
		2.910	3.000	3.090	
Quiescent Current	$I_O = 100\ \mu\text{A}$, $8V \leq V_{IN} \leq 24V$		15	20	μA
	$I_O = 10\ \text{mA}$, $8V \leq V_{IN} \leq 24V$		0.20	0.50	mA
	$I_O = 50\ \text{mA}$, $8V \leq V_{IN} \leq 24V$		1.5	2.5	mA
Line Regulation	$9V \leq V_{IN} \leq 16V$		5	10	mV
	$6V \leq V_{IN} \leq 40V$, $I_O = 1\ \text{mA}$		10	30	
Load Regulation	$100\ \mu\text{A} \leq I_O \leq 5\ \text{mA}$		10	30	mV
	$5\ \text{mA} \leq I_O \leq 50\ \text{mA}$		10	30	
Dropout Voltage	$I_O = 100\ \mu\text{A}$		0.05	0.10	V
	$I_O = 50\ \text{mA}$		0.20	0.40	V
Short Circuit Current	$V_O = 0V$	65	120	250	mA
Output Impedance	$I_O = 30\ \text{mAdc}$ and $10\ \text{mArms}$, $f = 1000\ \text{Hz}$		450		$\text{m}\Omega$
Output Noise Voltage	10 Hz–100 kHz		500		μV
Long Term Stability			20		mV/1000 Hr
Ripple Rejection	$V_{\text{ripple}} = 1V_{\text{rms}}$, $f_{\text{ripple}} = 120\ \text{Hz}$	-40	-60		dB
Reverse Polarity Transient Input Voltage	$R_L = 500\ \Omega$, $T = 1\ \text{ms}$	-50	-80		V
Output Voltage with Reverse Polarity Input	$V_{IN} = -15V$, $R_L = 500\ \Omega$		0.00	-0.30	V
Maximum Line Transient	$R_L = 500\ \Omega$, $V_O \leq 3.30V$, $T = 40\text{ms}$	60			V
Output Bypass Capacitance (C_{OUT}) ESR	$C_{OUT} = 22\ \mu\text{F}$ $0.1\ \text{mA} \leq I_{OUT} \leq 50\ \text{mA}$	0.3		8	Ω
Shutdown Input – LM2936BM–3.0 Only					

(1) Datasheet min/max specification limits are ensured by design, test, or statistical analysis.

(2) Typicals are at 25°C (unless otherwise specified) and represent the most likely parametric norm.

(3) To ensure constant junction temperature, pulse testing is used.

Electrical Characteristics for LM2936–3.0 (continued)

$V_{IN} = 14V$, $I_O = 10\text{ mA}$, $T_J = 25^\circ\text{C}$, unless otherwise specified. **Boldface** limits apply over entire operating temperature range

Parameter	Conditions	Min (1)	Typical (2)	Max (1)	Units
Output Voltage, V_{OUT}	Output Off, $V_{SD}=2.4V$, $R_{LOAD} = 500\Omega$		0	0.010	V
Shutdown High Threshold Voltage, V_{IH}	Output Off, $R_{LOAD} = 500\Omega$	2.00	1.1		V
Shutdown Low Threshold Voltage, V_{IL}	Output On, $R_{LOAD} = 500\Omega$		1.1	0.60	V
Shutdown High Current, I_{IH}	Output Off, $V_{SD} = 2.4V$, $R_{LOAD} = 500\Omega$		12		μA
Quiescent Current	Output Off, $V_{SD} = 2.4V$, $R_{LOAD} = 500\Omega$ Includes I_{IH} Current		30		μA

Electrical Characteristics for LM2936–3.3

$V_{IN} = 14V$, $I_O = 10\text{ mA}$, $T_J = 25^\circ\text{C}$, unless otherwise specified. **Boldface** limits apply over entire operating temperature range

Parameter	Conditions	Min (1)	Typical (2)	Max (1)	Units
LM2936HV–3.3 Only					
Output Voltage	$5.5V \leq V_{IN} \leq 48V$, $100\ \mu\text{A} \leq I_O \leq 50\text{ mA}$ (3)	3.201	3.300	3.399	V
Line Regulation	$6V \leq V_{IN} \leq 60V$, $I_O = 1\text{ mA}$		10	30	mV
All LM2936–3.3					
Output Voltage	$4.0V \leq V_{IN} \leq 26V$, $100\ \mu\text{A} \leq I_O \leq 50\text{ mA}$ (3)	3.234	3.300	3.366	V
Quiescent Current	$I_O = 100\ \mu\text{A}$, $8V \leq V_{IN} \leq 24V$		15	20	
	$I_O = 10\text{ mA}$, $8V \leq V_{IN} \leq 24V$		0.20	0.50	mA
	$I_O = 50\text{ mA}$, $8V \leq V_{IN} \leq 24V$		1.5	2.5	mA
Line Regulation	$9V \leq V_{IN} \leq 16V$		5	10	mV
	$6V \leq V_{IN} \leq 40V$, $I_O = 1\text{ mA}$		10	30	
Load Regulation	$100\ \mu\text{A} \leq I_O \leq 5\text{ mA}$		10	30	mV
	$5\text{ mA} \leq I_O \leq 50\text{ mA}$		10	30	
Dropout Voltage	$I_O = 100\ \mu\text{A}$		0.05	0.10	V
	$I_O = 50\text{ mA}$		0.20	0.40	V
Short Circuit Current	$V_O = 0V$	65	120	250	mA
Output Impedance	$I_O = 30\text{ mAdc}$ and 10 mArms , $f = 1000\text{ Hz}$		450		m Ω
Output Noise Voltage	10 Hz–100 kHz		500		μV
Long Term Stability			20		mV/1000 Hr
Ripple Rejection	$V_{\text{ripple}} = 1V_{\text{rms}}$, $f_{\text{ripple}} = 120\text{ Hz}$	-40	-60		dB
Reverse Polarity Transient Input Voltage	$R_L = 500\Omega$, $T = 1\text{ ms}$	-50	-80		V
Output Voltage with Reverse Polarity Input	$V_{IN} = -15V$, $R_L = 500\Omega$		0.00	-0.30	V
Maximum Line Transient	$R_L = 500\Omega$, $V_O \leq 3.63V$, $T = 40\text{ms}$	60			V
Output Bypass Capacitance (C_{OUT}) ESR	$C_{OUT} = 22\ \mu\text{F}$ $0.1\text{ mA} \leq I_{OUT} \leq 50\text{ mA}$	0.3		8	Ω
Shutdown Input – LM2936BM–3.3 Only					
Output Voltage, V_{OUT}	Output Off, $V_{SD}=2.4V$, $R_{LOAD} = 500\Omega$		0	0.010	V

(1) Datasheet min/max specification limits are ensured by design, test, or statistical analysis.

(2) Typicals are at 25°C (unless otherwise specified) and represent the most likely parametric norm.

(3) To ensure constant junction temperature, pulse testing is used.

Electrical Characteristics for LM2936–3.3 (continued)
 $V_{IN} = 14V$, $I_O = 10\text{ mA}$, $T_J = 25^\circ\text{C}$, unless otherwise specified. **Boldface** limits apply over entire operating temperature range

Parameter	Conditions	Min (1)	Typical (2)	Max (1)	Units
Shutdown High Threshold Voltage, V_{IH}	Output Off, $R_{LOAD} = 500\Omega$	2.00	1.1		V
Shutdown Low Threshold Voltage, V_{IL}	Output On, $R_{LOAD} = 500\Omega$		1.1	0.60	V
Shutdown High Current, I_{IH}	Output Off, $V_{SD} = 2.4V$, $R_{LOAD} = 500\Omega$		12		μA
Quiescent Current	Output Off, $V_{SD} = 2.4V$, $R_{LOAD} = 500\Omega$ Includes I_{IH} Current		30		μA

Electrical Characteristics for LM2936–5.0
 $V_{IN} = 14V$, $I_O = 10\text{ mA}$, $T_J = 25^\circ\text{C}$, unless otherwise specified. **Boldface** limits apply over entire operating temperature range

Parameter	Conditions	Min (1)	Typical (2)	Max (1)	Units
LM2936HV–5.0 Only					
Output Voltage	$5.5V \leq V_{IN} \leq 48V$, $100\ \mu\text{A} \leq I_O \leq 50\text{ mA}$ (3)	4.85	5.00	5.15	V
Line Regulation	$6V \leq V_{IN} \leq 60V$, $I_O = 1\text{ mA}$		15	35	mV
All LM2936–5.0					
Output Voltage	$5.5V \leq V_{IN} \leq 26V$, $100\ \mu\text{A} \leq I_O \leq 50\text{ mA}$ (3)	4.90	5.00	5.10	V
		4.85	5.00	5.15	
Quiescent Current	$I_O = 100\ \mu\text{A}$, $8V \leq V_{IN} \leq 24V$		9	15	μA
	$I_O = 10\text{ mA}$, $8V \leq V_{IN} \leq 24V$		0.20	0.50	mA
	$I_O = 50\text{ mA}$, $8V \leq V_{IN} \leq 24V$		1.5	2.5	mA
Line Regulation	$9V \leq V_{IN} \leq 16V$		5	10	mV
	$6V \leq V_{IN} \leq 40V$, $I_O = 1\text{ mA}$		10	30	
Load Regulation	$100\ \mu\text{A} \leq I_O \leq 5\text{ mA}$		10	30	mV
	$5\text{ mA} \leq I_O \leq 50\text{ mA}$		10	30	
Dropout Voltage	$I_O = 100\ \mu\text{A}$		0.05	0.10	V
	$I_O = 50\text{ mA}$		0.20	0.40	V
Short Circuit Current	$V_O = 0V$	65	120	250	mA
Output Impedance	$I_O = 30\text{ mAdc}$ and 10 mArms , $f = 1000\text{ Hz}$		450		$\text{m}\Omega$
Output Noise Voltage	10 Hz–100 kHz		500		μV
Long Term Stability			20		mV/1000 Hr
Ripple Rejection	$V_{\text{ripple}} = 1V_{\text{rms}}$, $f_{\text{ripple}} = 120\text{ Hz}$	-40	-60		dB
Reverse Polarity Transient Input Voltage	$R_L = 500\Omega$, $T = 1\text{ ms}$	-50	-80		V
Output Voltage with Reverse Polarity Input	$V_{IN} = -15V$, $R_L = 500\Omega$		0.00	-0.30	V
Maximum Line Transient	$R_L = 500\Omega$, $V_O \leq 5.5V$, $T = 40\text{ ms}$	60			V
Output Bypass Capacitance (C_{OUT}) ESR	$C_{OUT} = 10\ \mu\text{F}$ $0.1\text{ mA} \leq I_{OUT} \leq 50\text{ mA}$	0.3		8	Ω
Shutdown Input – LM2936BM–5.0 Only					
Output Voltage, V_{OUT}	Output Off, $V_{SD} = 2.4V$, $R_{LOAD} = 500\Omega$		0	0.010	V
Shutdown High Threshold Voltage, V_{IH}	Output Off, $R_{LOAD} = 500\Omega$	2.00	1.1		V

(1) Datasheet min/max specification limits are ensured by design, test, or statistical analysis.

 (2) Typicals are at 25°C (unless otherwise specified) and represent the most likely parametric norm.

(3) To ensure constant junction temperature, pulse testing is used.

Electrical Characteristics for LM2936–5.0 (continued)
 $V_{IN} = 14V$, $I_O = 10\text{ mA}$, $T_J = 25^\circ\text{C}$, unless otherwise specified. **Boldface** limits apply over entire operating temperature range

Parameter	Conditions	Min (1)	Typical (2)	Max (1)	Units
Shutdown Low Threshold Voltage, V_{IL}	Output On, $R_{LOAD} = 500\Omega$		1.1	0.60	V
Shutdown High Current, I_{IH}	Output Off, $V_{SD} = 2.4V$, $R_{LOAD} = 500\Omega$		12		μA
Quiescent Current	Output Off, $V_{SD} = 2.4V$, $R_{LOAD} = 500\Omega$ Includes I_{IH} Current		30		μA

Typical Performance Characteristics

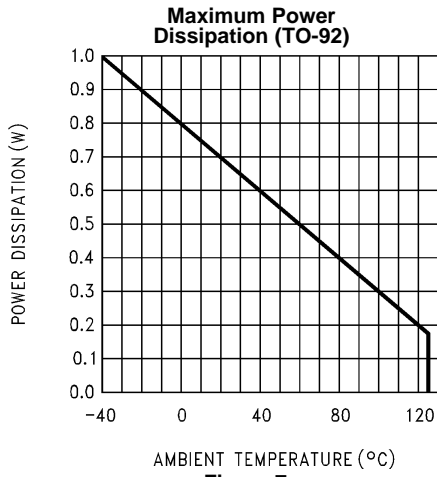


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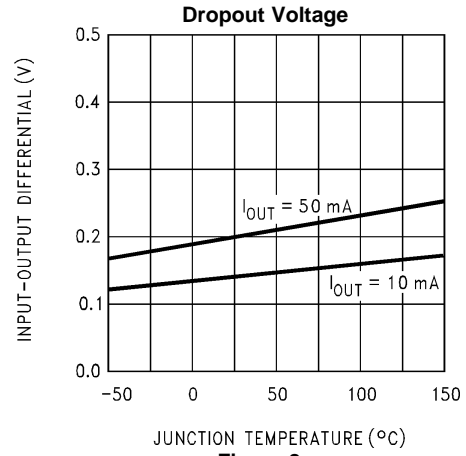


Figure 8.

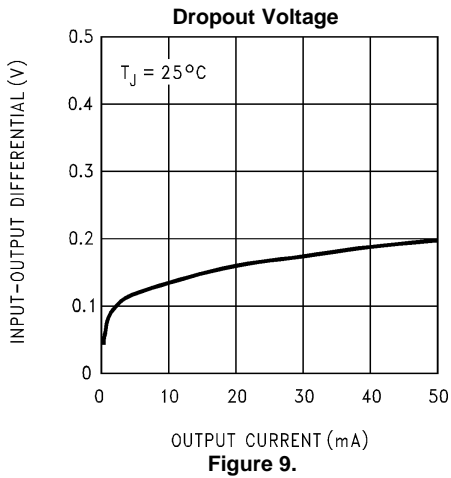


Figure 9.

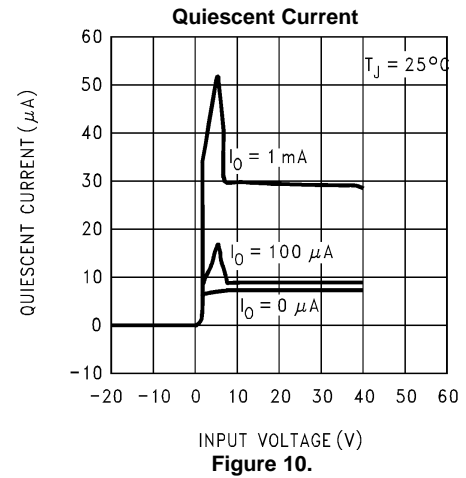


Figure 10.

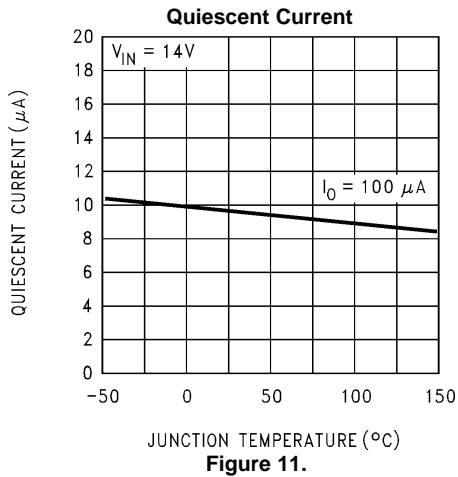


Figure 11.

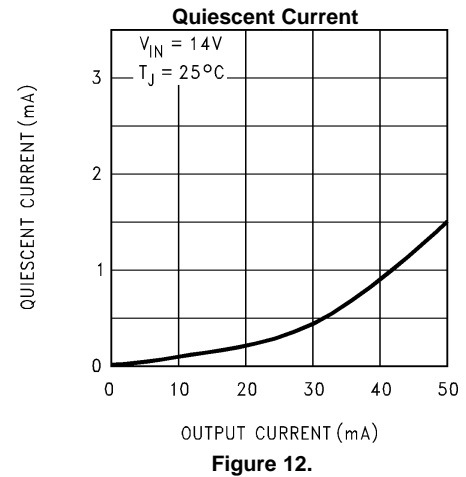


Figure 12.

Typical Performance Characteristics (continued)

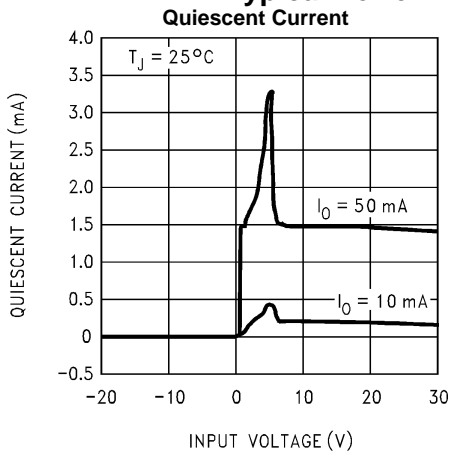


Figure 13.

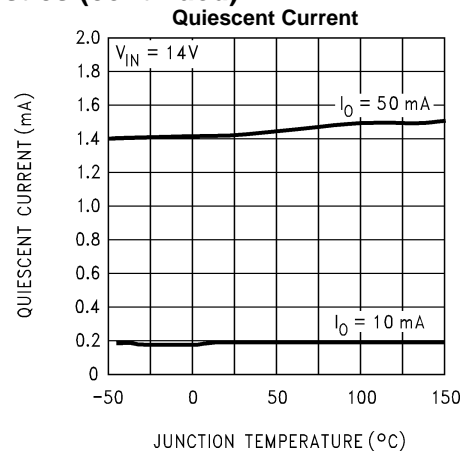


Figure 14.

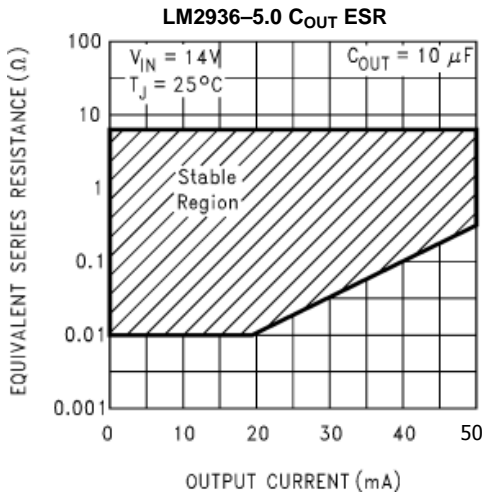


Figure 15.

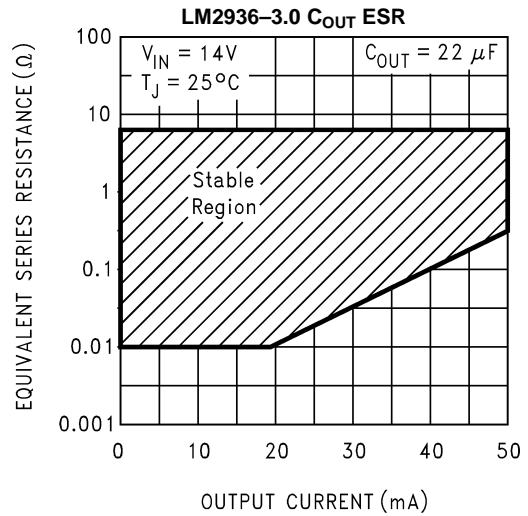


Figure 16.

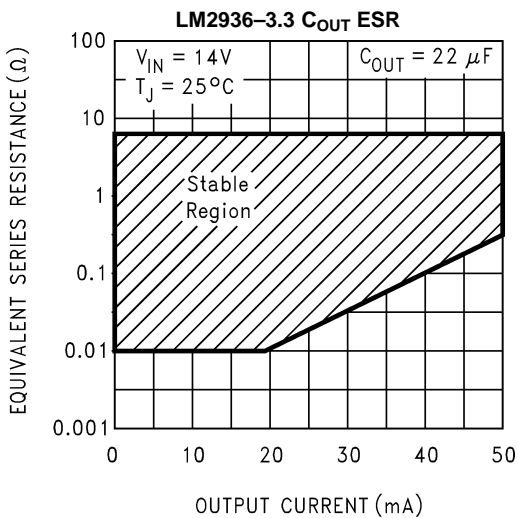


Figure 17.

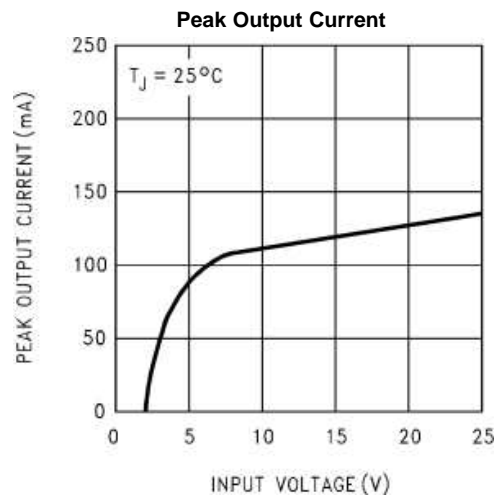


Figure 18.

Typical Performance Characteristics (continued)

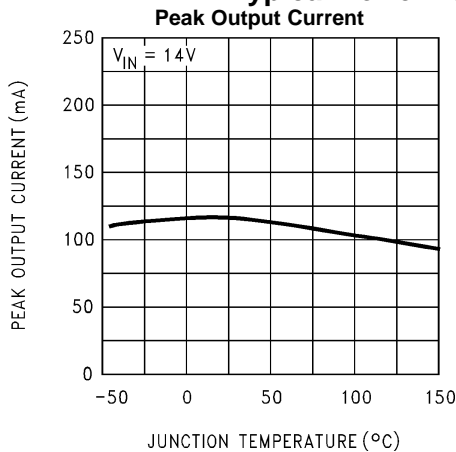


Figure 19.

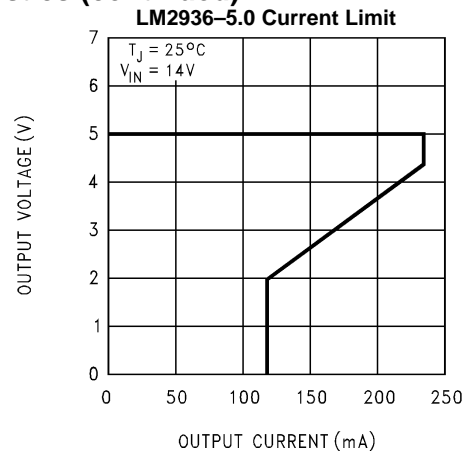


Figure 20.

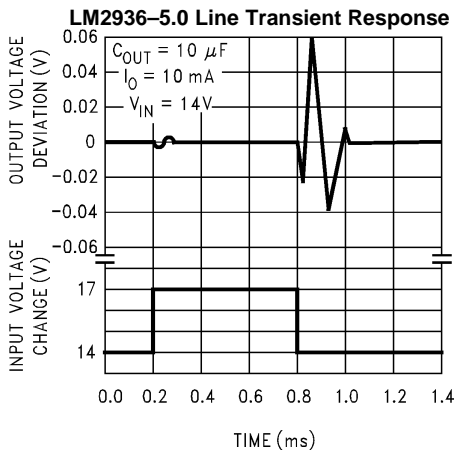


Figure 21.

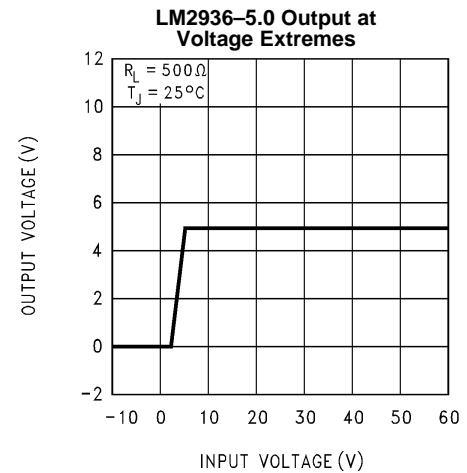


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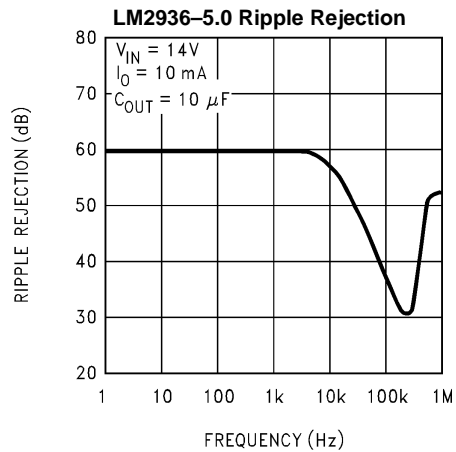


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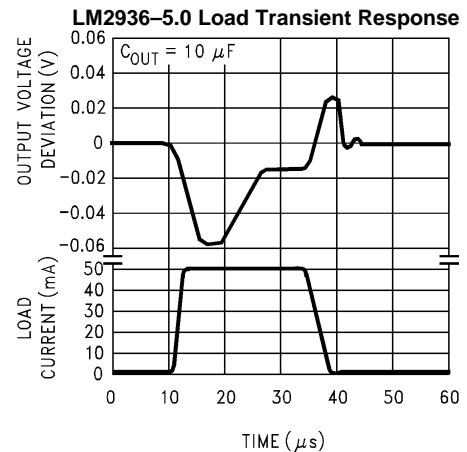
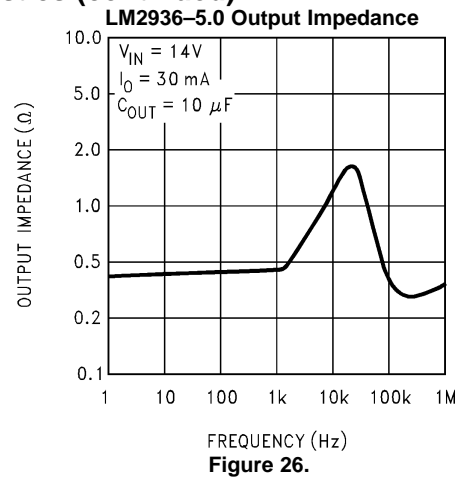
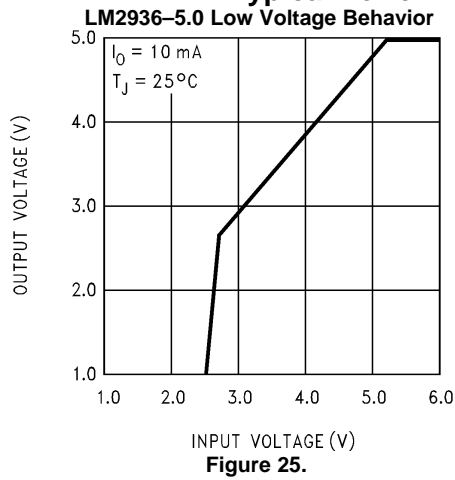


Figure 24.

Typical Performance Characteristics (continued)



APPLICATIONS INFORMATION

Unlike other PNP low dropout regulators, the LM2936 remains fully operational to 40V. Owing to power dissipation characteristics of the available packages, full output current cannot be ensured for all combinations of ambient temperature and input voltage. As an example, consider an LM2936Z–5.0 operating at 25°C ambient. Using the formula for maximum allowable power dissipation given in ⁽¹⁾, we find that $P_{Dmax} = 641 \text{ mW}$ at 25°C. Including the small contribution of the quiescent current to total power dissipation the maximum input voltage (while still delivering 50 mA output current) is 17.3V. The LM2936Z–5.0 will go into thermal shutdown if it attempts to deliver full output current with an input voltage of more than 17.3V. Similarly, at 40V input and 25°C ambient the LM2936Z–5.0 can deliver 18 mA maximum.

Under conditions of higher ambient temperatures, the voltage and current calculated in the previous examples will drop. For instance, at the maximum ambient of 125°C the LM2936Z–5.0 can only dissipate 128 mW, limiting the input voltage to 7.34V for a 50 mA load, or 3.5 mA output current for a 40V input.

The junction to ambient thermal resistance θ_{JA} rating has two distinct components: the junction to case thermal resistance rating θ_{JC} ; and the case to ambient thermal resistance rating θ_{CA} . The relationship is defined as: $\theta_{JA} = \theta_{JC} + \theta_{CA}$.

For the SOIC-8 and PFM surface mount packages the θ_{JA} rating can be improved by using the copper mounting pads on the printed circuit board as a thermal conductive path to extract heat from the package.

On the SOIC-8 package the four ground pins are thermally connected to the backside of the die. Adding approximately 0.04 square inches of 2 oz. copper pad area to these four pins will improve the θ_{JA} rating to approximately 110°C/W. If this extra pad are is placed directly beneath the package there should not be any impact on board density.

On the PFM package the ground tab is thermally connected to the backside of the die. Adding 1 square inch of 2 oz. copper pad area directly under the ground tab will improve the θ_{JA} rating to approximately 50°C/W.

While the LM2936 has an internally set thermal shutdown point of typically 160°C, this is intended as a safety feature only. Continuous operation near the thermal shutdown temperature should be avoided as it may have a negative affect on the life of the device.

While the LM2936 maintains regulation to 60V, it will not withstand a short circuit above 40V because of safe operating area limitations in the internal PNP pass device. Above 60V the LM2936 will break down with catastrophic effects on the regulator and possibly the load as well. Do not use this device in a design where the input operating voltage may exceed 40V, or where transients are likely to exceed 60V.

SHUTDOWN PIN

The LM2936BM has a pin for shutting down the regulator output. Applying a Logic Level High (>2.0V) to the Shutdown pin will cause the output to turn off. Leaving the Shutdown pin open, connecting it to Ground, or applying a Logic Level Low (<0.6V) will allow the regulator output to turn on.

(1) The maximum power dissipation is a function of T_{Jmax} , θ_{JA} , and T_A . The maximum allowable power dissipation at any ambient temperature is $P_D = (T_{Jmax} - T_A)/\theta_{JA}$. If this dissipation is exceeded, the die temperature will rise above 150°C and the LM2936 will go into thermal shutdown.

Equivalent Schematic Diagram

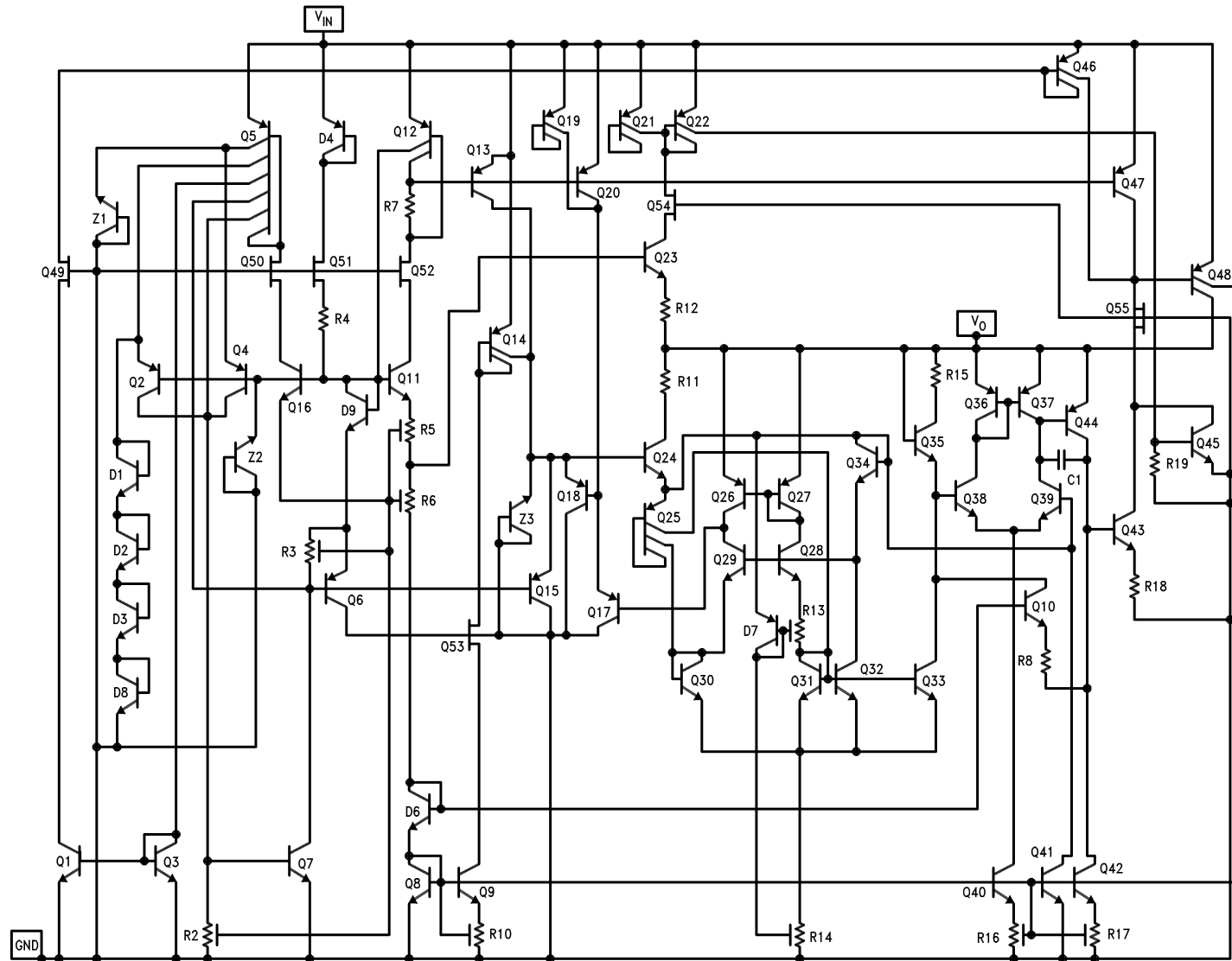


Figure 27.

REVISION HISTORY

Changes from Revision M (March 2013) to Revision N	Page
<hr/> <ul style="list-style-type: none">• Changed layout of National Data Sheet to TI format	<hr/> 12

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish	MSL Peak Temp (3)	Op Temp (°C)	Top-Side Markings (4)	Samples
LM2936BM-3.3	ACTIVE	SOIC	D	8	95	TBD	Call TI	Call TI	-40 to 125	LM293 6B3.3	Samples
LM2936BM-3.3/NOPB	ACTIVE	SOIC	D	8	95	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	LM293 6B3.3	Samples
LM2936BM-5.0	ACTIVE	SOIC	D	8	95	TBD	Call TI	Call TI	-40 to 125	LM293 6B5.0	Samples
LM2936BM-5.0/NOPB	ACTIVE	SOIC	D	8	95	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	LM293 6B5.0	Samples
LM2936BMX-3.3	ACTIVE	SOIC	D	8	2500	TBD	Call TI	Call TI	-40 to 125	LM293 6B3.3	Samples
LM2936BMX-3.3/NOPB	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	LM293 6B3.3	Samples
LM2936BMX-5.0	ACTIVE	SOIC	D	8	2500	TBD	Call TI	Call TI	-40 to 125	LM293 6B5.0	Samples
LM2936BMX-5.0/NOPB	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	LM293 6B5.0	Samples
LM2936DT-3.0	ACTIVE	PFM	NDP	3	75	TBD	Call TI	Call TI	-40 to 125	LM2936D T-3.0	Samples
LM2936DT-3.0/NOPB	ACTIVE	PFM	NDP	3	75	Green (RoHS & no Sb/Br)	CU SN	Level-2-260C-1 YEAR	-40 to 125	LM2936D T-3.0	Samples
LM2936DT-3.3	ACTIVE	PFM	NDP	3	75	TBD	Call TI	Call TI	-40 to 125	LM2936D T-3.3	Samples
LM2936DT-3.3/NOPB	ACTIVE	PFM	NDP	3	75	Green (RoHS & no Sb/Br)	CU SN	Level-2-260C-1 YEAR	-40 to 125	LM2936D T-3.3	Samples
LM2936DT-5.0	ACTIVE	PFM	NDP	3	75	TBD	Call TI	Call TI	-40 to 125	LM2936D T-5.0	Samples
LM2936DT-5.0/NOPB	ACTIVE	PFM	NDP	3	75	Green (RoHS & no Sb/Br)	CU SN	Level-2-260C-1 YEAR	-40 to 125	LM2936D T-5.0	Samples
LM2936DTX-3.0/NOPB	ACTIVE	PFM	NDP	3	2500	Green (RoHS & no Sb/Br)	CU SN	Level-2-260C-1 YEAR	-40 to 125	LM2936D T-3.0	Samples
LM2936DTX-3.3	ACTIVE	PFM	NDP	3	2500	TBD	Call TI	Call TI	-40 to 125		Samples
LM2936DTX-3.3/NOPB	ACTIVE	PFM	NDP	3	2500	Green (RoHS & no Sb/Br)	CU SN	Level-2-260C-1 YEAR	-40 to 125	LM2936D T-3.3	Samples

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish	MSL Peak Temp (3)	Op Temp (°C)	Top-Side Markings (4)	Samples
LM2936DTX-5.0	ACTIVE	PFM	NDP	3	2500	TBD	Call TI	Call TI	-40 to 125	LM2936D T-5.0	Samples
LM2936DTX-5.0/NOPB	ACTIVE	PFM	NDP	3	2500	Green (RoHS & no Sb/Br)	CU SN	Level-2-260C-1 YEAR	-40 to 125	LM2936D T-5.0	Samples
LM2936HVBMA-3.3	ACTIVE	SOIC	D	8	95	TBD	Call TI	Call TI	-40 to 125	2936H BM3.3	Samples
LM2936HVBMA-3.3/NOPB	ACTIVE	SOIC	D	8	95	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	2936H BM3.3	Samples
LM2936HVBMA-5.0	ACTIVE	SOIC	D	8	95	TBD	Call TI	Call TI	-40 to 125	2936H BM5.0	Samples
LM2936HVBMA-5.0/NOPB	ACTIVE	SOIC	D	8	95	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	2936H BM5.0	Samples
LM2936HVBMAX3.3	ACTIVE	SOIC	D	8	2500	TBD	Call TI	Call TI		2936H BM3.3	Samples
LM2936HVBMAX3.3/NOPB	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM		2936H BM3.3	Samples
LM2936HVBMAX5.0	ACTIVE	SOIC	D	8	2500	TBD	Call TI	Call TI		2936H BM5.0	Samples
LM2936HVBMAX5.0/NOPB	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM		2936H BM5.0	Samples
LM2936HVMA-5.0	ACTIVE	SOIC	D	8	95	TBD	Call TI	Call TI	-40 to 125	2936H M-5.0	Samples
LM2936HVMA-5.0/NOPB	ACTIVE	SOIC	D	8	95	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	2936H M-5.0	Samples
LM2936HVMAX-5.0	ACTIVE	SOIC	D	8	2500	TBD	Call TI	Call TI	-40 to 125	2936H M-5.0	Samples
LM2936HVMAX-5.0/NOPB	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	2936H M-5.0	Samples
LM2936M-3.0	ACTIVE	SOIC	D	8	95	TBD	Call TI	Call TI	-40 to 125	LM293 6M-3	Samples
LM2936M-3.0/NOPB	ACTIVE	SOIC	D	8	95	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	LM293 6M-3	Samples
LM2936M-3.3	ACTIVE	SOIC	D	8	95	TBD	Call TI	Call TI	-40 to 125	LM293 6-3.3	Samples
LM2936M-3.3/NOPB	ACTIVE	SOIC	D	8	95	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	LM293 6-3.3	Samples

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish	MSL Peak Temp (3)	Op Temp (°C)	Top-Side Markings (4)	Samples
LM2936M-5.0	ACTIVE	SOIC	D	8	95	TBD	Call TI	Call TI	-40 to 125	LM2936M-5	Samples
LM2936M-5.0/NOPB	ACTIVE	SOIC	D	8	95	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	LM2936M-5	Samples
LM2936MM-3.0	ACTIVE	VSSOP	DGK	8	1000	TBD	Call TI	Call TI	-40 to 125	KBC	Samples
LM2936MM-3.0/NOPB	ACTIVE	VSSOP	DGK	8	1000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	KBC	Samples
LM2936MM-3.3	ACTIVE	VSSOP	DGK	8	1000	TBD	Call TI	Call TI	-40 to 125	KBB	Samples
LM2936MM-3.3/NOPB	ACTIVE	VSSOP	DGK	8	1000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	KBB	Samples
LM2936MM-5.0	ACTIVE	VSSOP	DGK	8	1000	TBD	Call TI	Call TI	-40 to 125	KBA	Samples
LM2936MM-5.0/NOPB	ACTIVE	VSSOP	DGK	8	1000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	KBA	Samples
LM2936MMX-3.3	ACTIVE	VSSOP	DGK	8	3500	TBD	Call TI	Call TI	-40 to 125	KBB	Samples
LM2936MMX-3.3/NOPB	ACTIVE	VSSOP	DGK	8	3500	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	KBB	Samples
LM2936MMX-5.0	ACTIVE	VSSOP	DGK	8	3500	TBD	Call TI	Call TI	-40 to 125	KBA	Samples
LM2936MMX-5.0/NOPB	ACTIVE	VSSOP	DGK	8	3500	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	KBA	Samples
LM2936MP-3.0	ACTIVE	SOT-223	DCY	4	1000	TBD	Call TI	Call TI		KACA	Samples
LM2936MP-3.0/NOPB	ACTIVE	SOT-223	DCY	4	1000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM		KACA	Samples
LM2936MP-3.3	ACTIVE	SOT-223	DCY	4	1000	TBD	Call TI	Call TI	-40 to 125	KABA	Samples
LM2936MP-3.3/NOPB	ACTIVE	SOT-223	DCY	4	1000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	KABA	Samples
LM2936MP-5.0	ACTIVE	SOT-223	DCY	4	1000	TBD	Call TI	Call TI	-40 to 125	KAAA	Samples
LM2936MP-5.0/NOPB	ACTIVE	SOT-223	DCY	4	1000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	KAAA	Samples
LM2936MPX-3.0	ACTIVE	SOT-223	DCY	4	2000	TBD	Call TI	Call TI	-40 to 125	KACA	Samples

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish	MSL Peak Temp (3)	Op Temp (°C)	Top-Side Markings (4)	Samples
LM2936MPX-3.0/NOPB	ACTIVE	SOT-223	DCY	4	2000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	KACA	Samples
LM2936MPX-3.3	ACTIVE	SOT-223	DCY	4	2000	TBD	Call TI	Call TI	-40 to 125	KABA	Samples
LM2936MPX-3.3/NOPB	ACTIVE	SOT-223	DCY	4	2000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	KABA	Samples
LM2936MPX-5.0	ACTIVE	SOT-223	DCY	4	2000	TBD	Call TI	Call TI	-40 to 125	KAAA	Samples
LM2936MPX-5.0/NOPB	ACTIVE	SOT-223	DCY	4	2000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	KAAA	Samples
LM2936MX-3.3	ACTIVE	SOIC	D	8	2500	TBD	Call TI	Call TI	-40 to 125	LM2936-3.3	Samples
LM2936MX-3.3/NOPB	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	LM2936-3.3	Samples
LM2936MX-5.0	ACTIVE	SOIC	D	8	2500	TBD	Call TI	Call TI	-40 to 125	LM2936M-5	Samples
LM2936MX-5.0/NOPB	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	LM2936M-5	Samples
LM2936Z-3.0/NOPB	ACTIVE	TO-92	LP	3	1800	Green (RoHS & no Sb/Br)	SNCU	Level-1-NA-UNLIM	-40 to 125	LM2936Z-3	Samples
LM2936Z-3.3/NOPB	ACTIVE	TO-92	LP	3	1800	Green (RoHS & no Sb/Br)	SNCU	Level-1-NA-UNLIM	-40 to 125	LM2936Z-3.3	Samples
LM2936Z-5.0/LFT1	ACTIVE	TO-92	LP	3	2000	Green (RoHS & no Sb/Br)	SNCU	Level-1-NA-UNLIM		LM2936Z-5	Samples
LM2936Z-5.0/LFT3	ACTIVE	TO-92	LP	3	2000	Green (RoHS & no Sb/Br)	SNCU	Level-1-NA-UNLIM		LM2936Z-5	Samples
LM2936Z-5.0/LFT4	ACTIVE	TO-92	LP	3	2000	Green (RoHS & no Sb/Br)	SNCU	Level-1-NA-UNLIM		LM2936Z-5	Samples
LM2936Z-5.0/NOPB	ACTIVE	TO-92	LP	3	1800	Green (RoHS & no Sb/Br)	SNCU	Level-1-NA-UNLIM	-40 to 125	LM2936Z-5	Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

⁽⁴⁾ Only one of markings shown within the brackets will appear on the physical device.

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TAPE AND REEL INFORMATION

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE


*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
LM2936BMX-3.3	SOIC	D	8	2500	330.0	12.4	6.5	5.4	2.0	8.0	12.0	Q1
LM2936BMX-3.3/NOPB	SOIC	D	8	2500	330.0	12.4	6.5	5.4	2.0	8.0	12.0	Q1
LM2936BMX-5.0	SOIC	D	8	2500	330.0	12.4	6.5	5.4	2.0	8.0	12.0	Q1
LM2936BMX-5.0/NOPB	SOIC	D	8	2500	330.0	12.4	6.5	5.4	2.0	8.0	12.0	Q1
LM2936DTX-3.0/NOPB	PFM	NDP	3	2500	330.0	16.4	6.9	10.5	2.7	8.0	16.0	Q2
LM2936DTX-3.3/NOPB	PFM	NDP	3	2500	330.0	16.4	6.9	10.5	2.7	8.0	16.0	Q2
LM2936DTX-5.0	PFM	NDP	3	2500	330.0	16.4	6.9	10.5	2.7	8.0	16.0	Q2
LM2936DTX-5.0/NOPB	PFM	NDP	3	2500	330.0	16.4	6.9	10.5	2.7	8.0	16.0	Q2
LM2936HVBMAX3.3	SOIC	D	8	2500	330.0	12.4	6.5	5.4	2.0	8.0	12.0	Q1
LM2936HVBMAX3.3/NOPB	SOIC	D	8	2500	330.0	12.4	6.5	5.4	2.0	8.0	12.0	Q1
LM2936HVBMAX5.0	SOIC	D	8	2500	330.0	12.4	6.5	5.4	2.0	8.0	12.0	Q1
LM2936HVBMAX5.0/NOPB	SOIC	D	8	2500	330.0	12.4	6.5	5.4	2.0	8.0	12.0	Q1
LM2936HVMAX-5.0	SOIC	D	8	2500	330.0	12.4	6.5	5.4	2.0	8.0	12.0	Q1
LM2936HVMAX-5.0/NOPB	SOIC	D	8	2500	330.0	12.4	6.5	5.4	2.0	8.0	12.0	Q1
LM2936MM-3.0	VSSOP	DGK	8	1000	178.0	12.4	5.3	3.4	1.4	8.0	12.0	Q1
LM2936MM-3.0/NOPB	VSSOP	DGK	8	1000	178.0	12.4	5.3	3.4	1.4	8.0	12.0	Q1

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
LM2936MM-3.3	VSSOP	DGK	8	1000	178.0	12.4	5.3	3.4	1.4	8.0	12.0	Q1
LM2936MM-3.3/NOPB	VSSOP	DGK	8	1000	178.0	12.4	5.3	3.4	1.4	8.0	12.0	Q1
LM2936MM-5.0	VSSOP	DGK	8	1000	178.0	12.4	5.3	3.4	1.4	8.0	12.0	Q1
LM2936MM-5.0/NOPB	VSSOP	DGK	8	1000	178.0	12.4	5.3	3.4	1.4	8.0	12.0	Q1
LM2936MMX-3.3	VSSOP	DGK	8	3500	330.0	12.4	5.3	3.4	1.4	8.0	12.0	Q1
LM2936MMX-3.3/NOPB	VSSOP	DGK	8	3500	330.0	12.4	5.3	3.4	1.4	8.0	12.0	Q1
LM2936MMX-5.0	VSSOP	DGK	8	3500	330.0	12.4	5.3	3.4	1.4	8.0	12.0	Q1
LM2936MMX-5.0/NOPB	VSSOP	DGK	8	3500	330.0	12.4	5.3	3.4	1.4	8.0	12.0	Q1
LM2936MP-3.0	SOT-223	DCY	4	1000	330.0	16.4	7.0	7.5	2.2	12.0	16.0	Q3
LM2936MP-3.0/NOPB	SOT-223	DCY	4	1000	330.0	16.4	7.0	7.5	2.2	12.0	16.0	Q3
LM2936MP-3.3	SOT-223	DCY	4	1000	330.0	16.4	7.0	7.5	2.2	12.0	16.0	Q3
LM2936MP-3.3/NOPB	SOT-223	DCY	4	1000	330.0	16.4	7.0	7.5	2.2	12.0	16.0	Q3
LM2936MP-5.0	SOT-223	DCY	4	1000	330.0	16.4	7.0	7.5	2.2	12.0	16.0	Q3
LM2936MP-5.0/NOPB	SOT-223	DCY	4	1000	330.0	16.4	7.0	7.5	2.2	12.0	16.0	Q3
LM2936MPX-3.0	SOT-223	DCY	4	2000	330.0	16.4	7.0	7.5	2.2	12.0	16.0	Q3
LM2936MPX-3.0/NOPB	SOT-223	DCY	4	2000	330.0	16.4	7.0	7.5	2.2	12.0	16.0	Q3
LM2936MPX-3.3	SOT-223	DCY	4	2000	330.0	16.4	7.0	7.5	2.2	12.0	16.0	Q3
LM2936MPX-3.3/NOPB	SOT-223	DCY	4	2000	330.0	16.4	7.0	7.5	2.2	12.0	16.0	Q3
LM2936MPX-5.0	SOT-223	DCY	4	2000	330.0	16.4	7.0	7.5	2.2	12.0	16.0	Q3
LM2936MPX-5.0/NOPB	SOT-223	DCY	4	2000	330.0	16.4	7.0	7.5	2.2	12.0	16.0	Q3
LM2936MX-3.3	SOIC	D	8	2500	330.0	12.4	6.5	5.4	2.0	8.0	12.0	Q1
LM2936MX-3.3/NOPB	SOIC	D	8	2500	330.0	12.4	6.5	5.4	2.0	8.0	12.0	Q1
LM2936MX-5.0	SOIC	D	8	2500	330.0	12.4	6.5	5.4	2.0	8.0	12.0	Q1
LM2936MX-5.0/NOPB	SOIC	D	8	2500	330.0	12.4	6.5	5.4	2.0	8.0	12.0	Q1

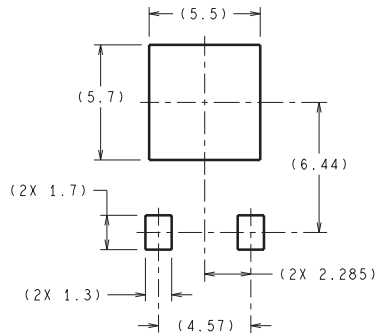
TAPE AND REEL BOX DIMENSIONS


*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
LM2936BMX-3.3	SOIC	D	8	2500	367.0	367.0	35.0
LM2936BMX-3.3/NOPB	SOIC	D	8	2500	367.0	367.0	35.0
LM2936BMX-5.0	SOIC	D	8	2500	367.0	367.0	35.0
LM2936BMX-5.0/NOPB	SOIC	D	8	2500	367.0	367.0	35.0
LM2936DTX-3.0/NOPB	PFM	NDP	3	2500	358.0	343.0	63.0
LM2936DTX-3.3/NOPB	PFM	NDP	3	2500	358.0	343.0	63.0
LM2936DTX-5.0	PFM	NDP	3	2500	354.0	340.0	35.0
LM2936DTX-5.0/NOPB	PFM	NDP	3	2500	358.0	343.0	63.0
LM2936HVBMAX3.3	SOIC	D	8	2500	367.0	367.0	35.0
LM2936HVBMAX3.3/NOPB	SOIC	D	8	2500	367.0	367.0	35.0
LM2936HVBMAX5.0	SOIC	D	8	2500	367.0	367.0	35.0
LM2936HVBMAX5.0/NOPB	SOIC	D	8	2500	367.0	367.0	35.0
LM2936HVMAX-5.0	SOIC	D	8	2500	367.0	367.0	35.0
LM2936HVMAX-5.0/NOPB	SOIC	D	8	2500	367.0	367.0	35.0
LM2936MM-3.0	VSSOP	DGK	8	1000	210.0	185.0	35.0
LM2936MM-3.0/NOPB	VSSOP	DGK	8	1000	210.0	185.0	35.0
LM2936MM-3.3	VSSOP	DGK	8	1000	210.0	185.0	35.0
LM2936MM-3.3/NOPB	VSSOP	DGK	8	1000	210.0	185.0	35.0
LM2936MM-5.0	VSSOP	DGK	8	1000	210.0	185.0	35.0

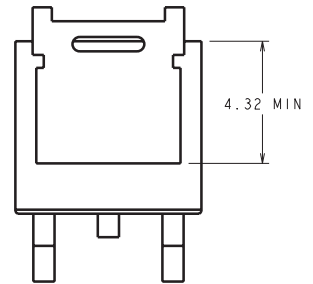
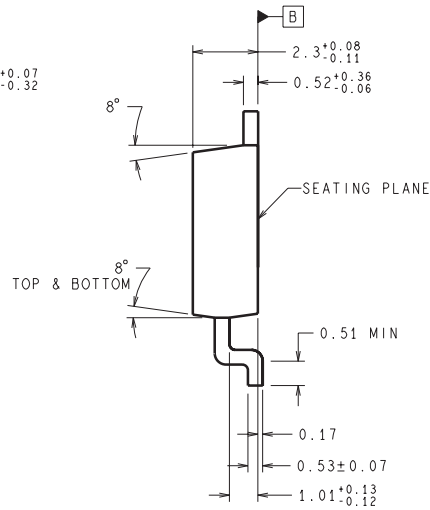
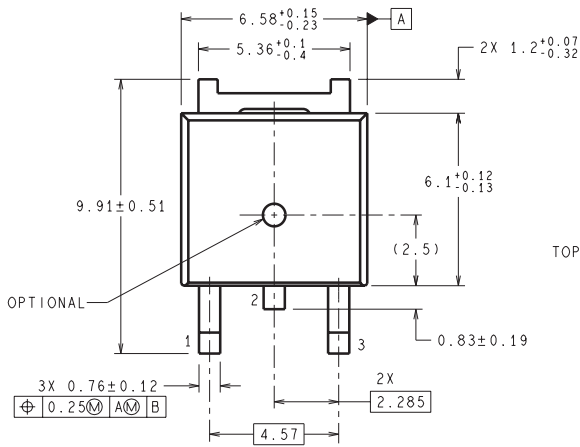
Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
LM2936MM-5.0/NOPB	VSSOP	DGK	8	1000	210.0	185.0	35.0
LM2936MMX-3.3	VSSOP	DGK	8	3500	367.0	367.0	35.0
LM2936MMX-3.3/NOPB	VSSOP	DGK	8	3500	367.0	367.0	35.0
LM2936MMX-5.0	VSSOP	DGK	8	3500	367.0	367.0	35.0
LM2936MMX-5.0/NOPB	VSSOP	DGK	8	3500	367.0	367.0	35.0
LM2936MP-3.0	SOT-223	DCY	4	1000	349.0	337.0	45.0
LM2936MP-3.0/NOPB	SOT-223	DCY	4	1000	349.0	337.0	45.0
LM2936MP-3.3	SOT-223	DCY	4	1000	349.0	337.0	45.0
LM2936MP-3.3/NOPB	SOT-223	DCY	4	1000	349.0	337.0	45.0
LM2936MP-5.0	SOT-223	DCY	4	1000	349.0	337.0	45.0
LM2936MP-5.0/NOPB	SOT-223	DCY	4	1000	349.0	337.0	45.0
LM2936MPX-3.0	SOT-223	DCY	4	2000	354.0	340.0	35.0
LM2936MPX-3.0/NOPB	SOT-223	DCY	4	2000	354.0	340.0	35.0
LM2936MPX-3.3	SOT-223	DCY	4	2000	354.0	340.0	35.0
LM2936MPX-3.3/NOPB	SOT-223	DCY	4	2000	354.0	340.0	35.0
LM2936MPX-5.0	SOT-223	DCY	4	2000	354.0	340.0	35.0
LM2936MPX-5.0/NOPB	SOT-223	DCY	4	2000	354.0	340.0	35.0
LM2936MX-3.3	SOIC	D	8	2500	367.0	367.0	35.0
LM2936MX-3.3/NOPB	SOIC	D	8	2500	367.0	367.0	35.0
LM2936MX-5.0	SOIC	D	8	2500	367.0	367.0	35.0
LM2936MX-5.0/NOPB	SOIC	D	8	2500	367.0	367.0	35.0

NDP0003B



DIMENSIONS ARE IN MILLIMETERS
 DIMENSIONS IN () FOR REFERENCE ONLY

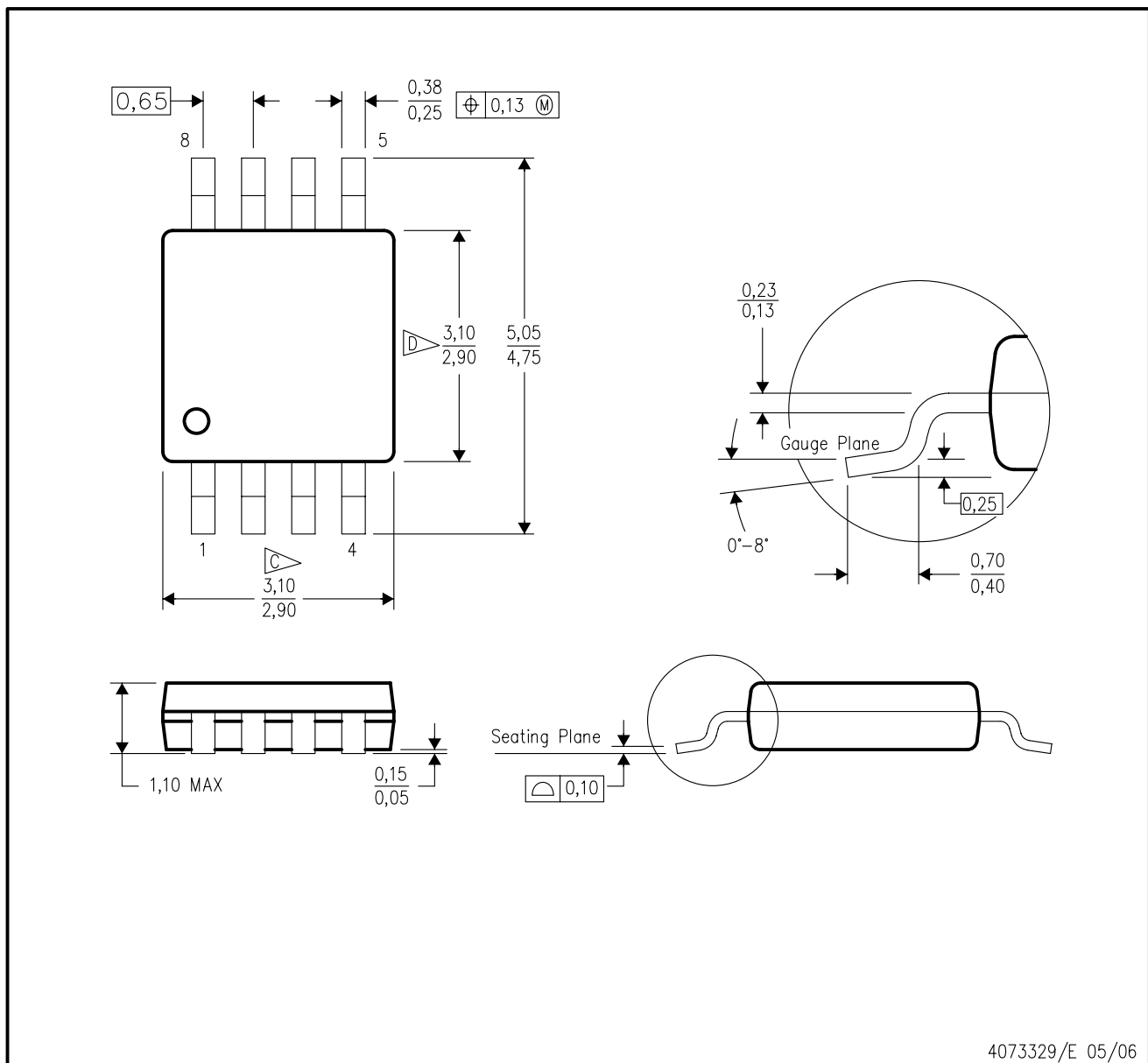
LAND PATTERN RECOMMENDATION



TD03B (Rev F)

DGK (S-PDSO-G8)

PLASTIC SMALL-OUTLINE PACKAGE



- NOTES:
- All linear dimensions are in millimeters.
 - This drawing is subject to change without notice.
 - Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 per end.
 - Body width does not include interlead flash. Interlead flash shall not exceed 0.50 per side.
 - Falls within JEDEC MO-187 variation AA, except interlead flash.

DCY (R-PDSO-G4)

PLASTIC SMALL-OUTLINE



- NOTES: A. All linear dimensions are in millimeters (inches).
 B. This drawing is subject to change without notice.
 C. Body dimensions do not include mold flash or protrusion.
 D. Falls within JEDEC TO-261 Variation AA.

D (R-PDSO-G8)

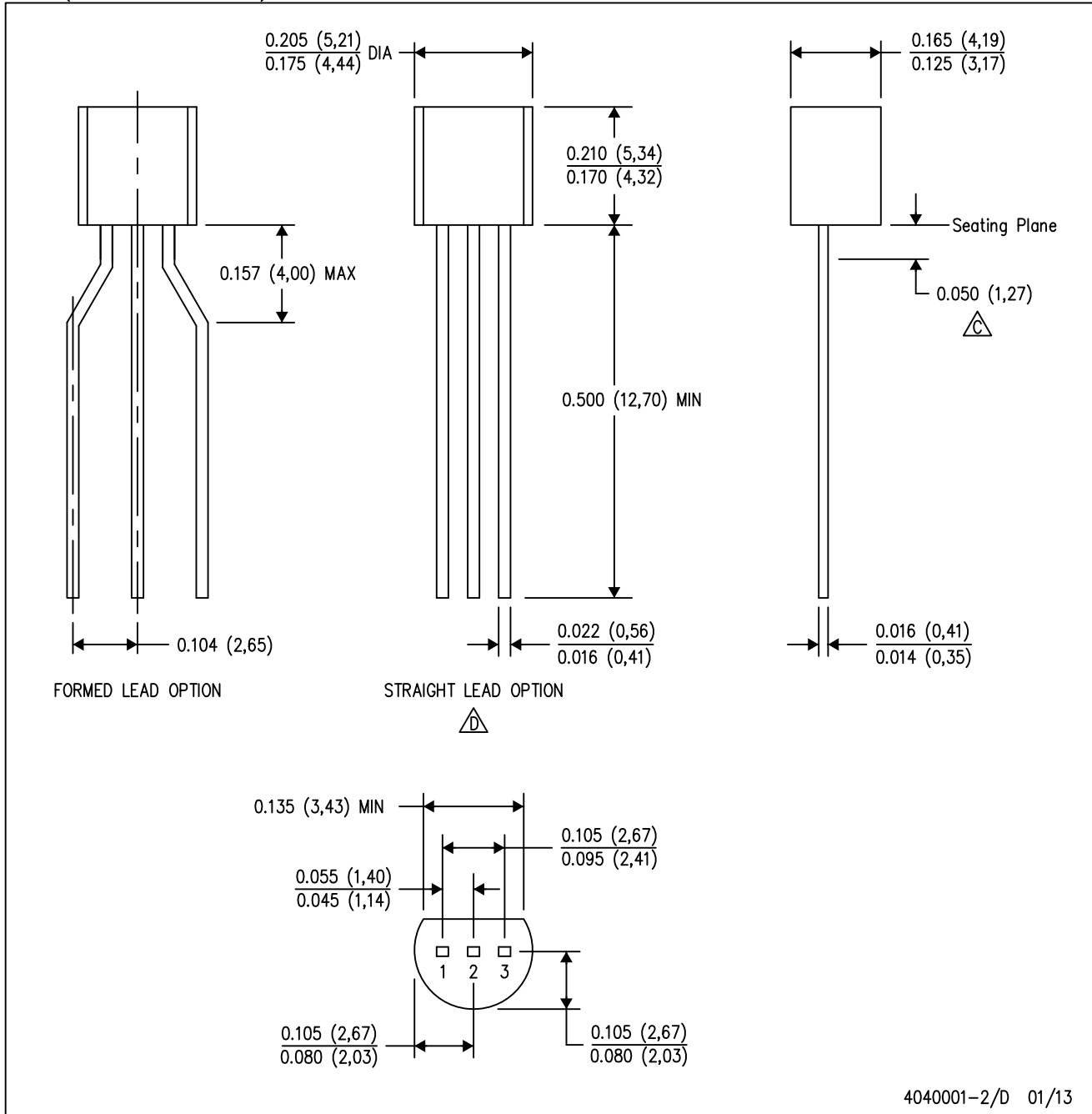
PLASTIC SMALL OUTLINE



- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - $\triangle C$ Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
 - $\triangle D$ Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
 - E. Reference JEDEC MS-012 variation AA.

LP (O-PBCY-W3)

PLASTIC CYLINDRICAL PACKAGE

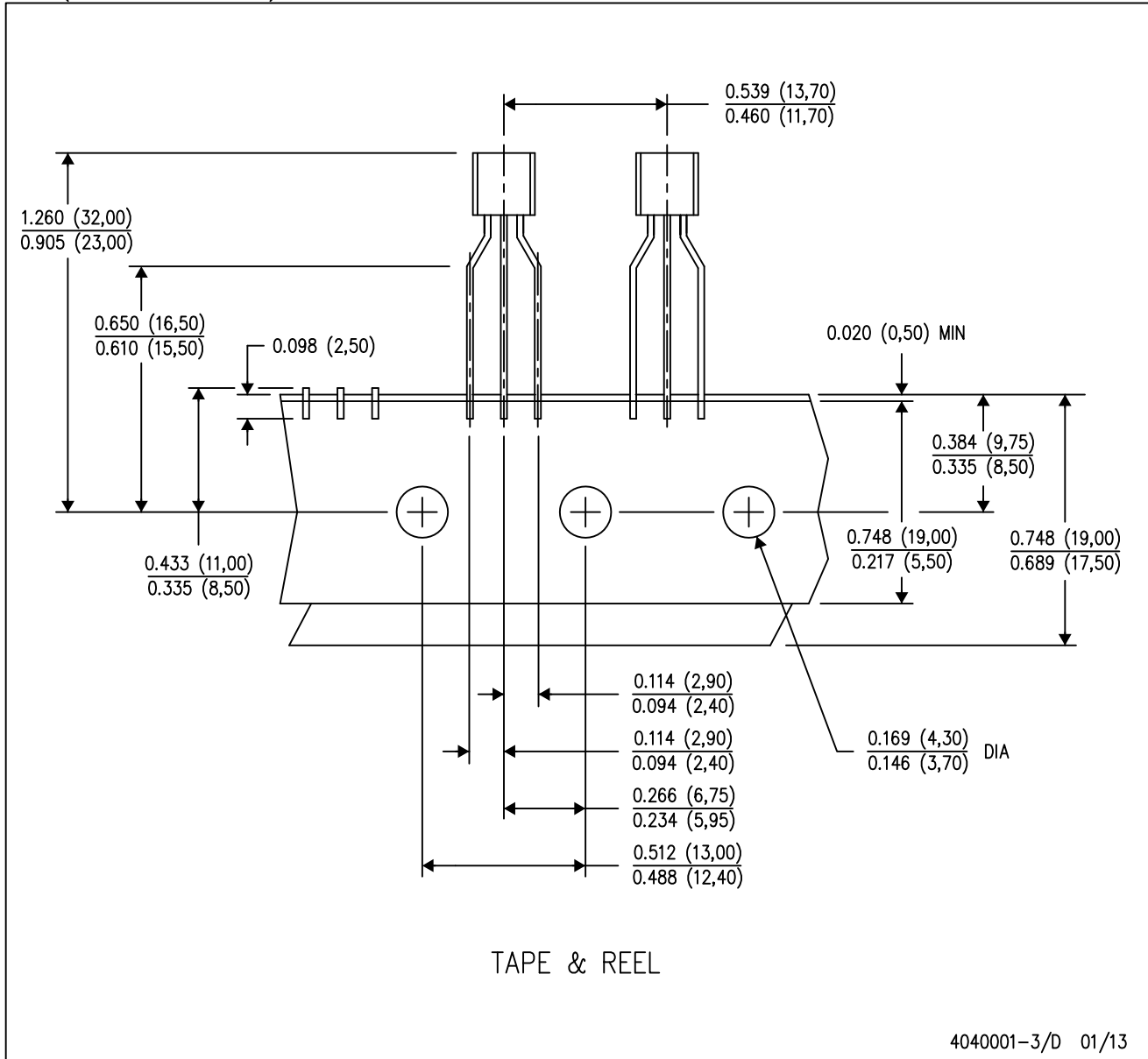


- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - $\triangle C$ Lead dimensions are not controlled within this area.
 - $\triangle D$ Falls within JEDEC TO-226 Variation AA (TO-226 replaces TO-92).
 - E. Shipping Method:
 - Straight lead option available in either bulk pack or tape & reel.
 - Formed lead option available in tape & reel or ammo pack.
 - Specific products can be offered in limited combinations of shipping mediums and lead options.
 - Consult product folder for more information on available options.

MECHANICAL DATA

LP (O-PBCY-W3)

PLASTIC CYLINDRICAL PACKAGE



- NOTES:
- All linear dimensions are in inches (millimeters).
 - This drawing is subject to change without notice.
 - Tape and Reel information for the Formed Lead Option package.

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